U.S. PTO		
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• 11/28/2007	ATTER WIN ATTER ANNO ATTER WAN AREA FATT (AND	
RECORI 103466108		
Docket No.: 075951-0021 PATENTS	ONLY	
To the Director of the U. S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.	
1. Name of Conveying Party(ies)	2. Name and address of receiving party(ies)	
Byung-Ho JUN, Jae-Woo JOUNG	Name: SAMSUNG ELECTRO-MECHANICS CO., LTD.	
	Internal Address:	
Additional name(s) of conveying party(ies) attached? Yes No		
3. Nature of Conveyance/Execution Date(s)	Address: 314, Maetan3-Dong, Yeongtong-Gu, Suwon	
Execution Date(s): November 8, 2007	Gyunggi-Do, KOREA 443-743	
🛛 Assignment 🗌 Merger		
Security Agreement Change of Name		
Joint Research Agreement		
Government Interest Assignment		
Executive Order 9424, Confirmatory License		
Other	Additional name(s) & address(es) attached? Yes No	
4. Application or patent number(s):	This document is being filed together with a new application	
A. Patent Application No(s).	B. Patent No(s).	
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Internal Address:	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00 Authorized to be charged by credit card	
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	Expiration Date b. Deposit Account Number 500417 Authorized User Name	
9. Signature. Sin K. Luch Res. No. 51,32)	Expiration Date b. Deposit Account Number 500417	

PATENT REEL: 020203 FRAME: 0071 Docket No.:

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

 Byung-Ho JUN
 (4)

 (2)
 Jae-Woo JOUNG
 (5)
 (3) : (6)

who have made a certain new and useful invention, hereby sell, assign and transfer unto ⁵ . . .

SAMSUNG ELECTRO-MECHANICS CO., LTD.

314, Maetan3-Dong, Yeongtong-Gu, Suwon Gyunggi-Do, Korea 443-743

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

METHOD FOR MANUFACTURING METAL NANOPARTICLES COMPRISING ROD-SHAPED NANOPARTICLES

(a) for which an application for United States Letters Patent was filed on , and identified by United States Serial No. ; or

(b) for which an application for United States Letters Patent was executed on,

and the undersigned hereby authorize and request the United States Commissioner for Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

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1)	INVENTORS	DATE SIGNED Llov. 8,~~~)
2)	Name: Brung-Ho JUN	Nov. 8, 2007.
3)	Name: Jae-Woo JOUNG	
4)	Name:	
5)	Name:	
6)	Name:	
	Name:	

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